

Docket No.: P-0445A



PATENT TPW

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Yong-II KIM, Sung-Gue LEE, and Yu-Seock YANG

Serial No: 10/743,302

ISSUE FEE DUE:
January 11, 2006

Confirmation No.: 7847

Group Art Unit: 2891

Filed: December 23, 2003

Examiner: David A. ZARNEKE

Customer No.: 34610

For: **METHOD FOR FABRICATING SEMICONDUCTOR PACKAGE AND SEMICONDUCTOR PACKAGE**

U.S. Patent and Trademark Office
Customer Window, MAIL STOP AF
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment under 37 C.F.R. §1.312 in the above identified application.

No additional fee is required.
 Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	29	29		x \$50.00 =	\$
Independent Claims	3	3		x \$200.00=	\$
If multiple claims newly presented, add \$360.00					
Fee for extension of time					
TOTAL FEE DUE					\$

Please charge my Deposit Account No. 16-0607 in the amount of \$ _____. An additional copy of this transmittal sheet is submitted herewith.

A check in the amount of \$ _____ (Check #_____) is attached.

The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,
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Date: November 17, 2005

Please direct all correspondence to Customer Number 34610

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

**Yong-Il KIM, Sung-Gue LEE,
and Yu-Seock YANG**

Serial No.: **10/743,302**

**ISSUE FEE DUE:
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Customer No.: **34610**

For: **METHOD FOR FABRICATING SEMICONDUCTOR PACKAGE AND
SEMICONDUCTOR PACKAGE**

AMENDMENT UNDER 37 C.F.R. § 1.312

U.S. Patent and Trademark Office
Customer Window, **MAIL STOP AF**
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Sir:

Further to the Notice of Allowance dated **October 11, 2005**, please amend the above-identified application as follows:

Amendments to the Specification are reflected in this paper.

Remarks/Arguments begin after the listing of the claims.